

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Raj PENDSE	Attorney Docket No.: CPAC 1011-2
Application No.: 10/081,425	Examiner: Scott B/ Geyer
Filed: 22 February 2002	Group: 9980
Title: Apparatus and process for precise encapsulation of flip chip interconnects	RECEIVED AUG 07 2003

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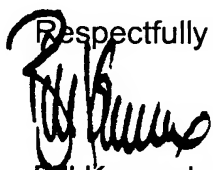
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Sir:

The undersigned, Bill Kennedy, Reg. No. 33,407, attorney of record in this application, hereby grants Annette Maciello and Rayline Petitt of Patent and Trademark Services the power to inspect and make copies of the subject application, including provisional patent application No. 60/272,280 from which this non-provisional application claims priority.

Respectfully submitted,



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